

# **Technical Data Sheet** High Power LED – 1W

## EHP-AX08EL/SUR01A-P01

#### **Features**

- Feature of the device: small package with high efficiency
- Typical view angle: 140°.
- Typical light flux output: 37 lm @ 350mA.
- ESD protection.
- Soldering methods: SMT.
- Grouping parameter: total luminous flux, dominant wavelength
- Typical optical efficiency: 46 lm/W.
- Thermal resistance (junction to lead): 15 K/W.
- The product itself will remain within RoHS compliant version

### **Applications**

- TFT LCD display backlight
- Decorative and entertainment illumination
- Signal and symbol luminaries for orientation marker lights (e.g. steps, exit ways, etc.)
- Exterior and interior automotive illumination

#### **Materials**

Items	Description	DZSC.COM
Housing black body	Heat resistant polymer	075
Encapsulating Resin	Silicone resin	
Lens	Silicone	
Electrodes	Ag plating copper alloy	
Die attach	Silver paste	一天面
Chip	AlGainP	CC.COM
	THE WWW	0250





Prepared by: Jessie Chueh

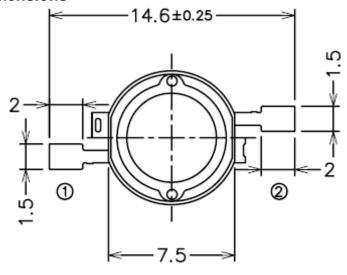
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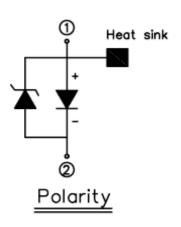
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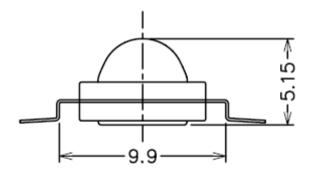


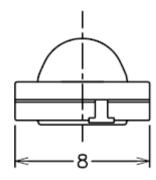
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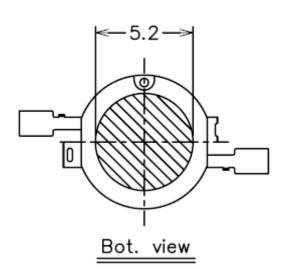
### **Dimensions**

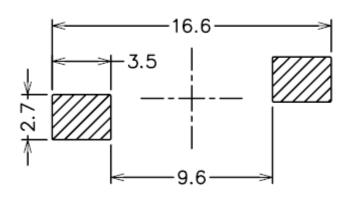












Soldering patterns

Notes: 1. Dimensions are in millimeters.

2. Tolerances unless dimensions ±0.25mm.

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Maximum Ratings (T Ambient=25°C)

Parameter	Symbol	Rating	Unit
Operating Temperature	T <sub>opr</sub>	-40 ~ +100	°C
Storage Temperature	$T_{stg}$	-40 ~ +110	°C
Junction temperature	$ au_j$	125	°C
Pulse Forward Current	I <sub>F</sub>	500	mA
Power Dissipation	P <sub>d</sub>	2.0	w
Junction to heat-sink thermal resistance	R <sub>th</sub>	15	K/W

**Electro-Optical Characteristics (***T*<sub>Ambient</sub>=25°C)

Parameter	Bin	Symbol	Min	Тур.	Max	Unit	Condition
Luminous Flux <sub>(1)</sub>	J3		33		39		
	J4	$oldsymbol{\phi}_{v}$	39		45	lm	
	J5		45		52		
	<b>K</b> 1		52		60		
Forward Voltage <sub>(2)</sub>	U2		2.05		2.35		I <sub>=</sub> =350mA
	U3	$V_{F}$	2.35		2.65	V	
	U4		2.65		2.95		
Viewing Angle <sub>(3)</sub>		<b>2θ</b> <sub>1/2</sub>		140		deg	
Wavelength <sub>(4)</sub>	R5	_	620		625		
	R6	$\lambda_d$	625		630	nm	

Note. 1. Luminous Flux measurement tolerance: ±10%

- 2. Forward Voltage measurement tolerance: ±0.1V
- 3.  $2\theta_{1/2}$  is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.

4. Wavelength measurement tolerance: ±1nm

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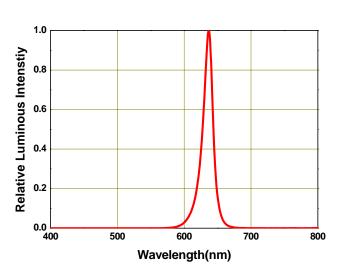
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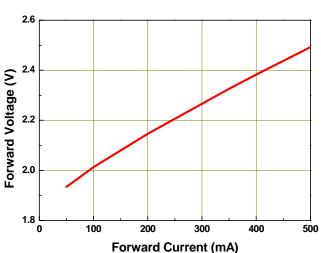
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### **Typical Electro-Optical Characteristics Curves**

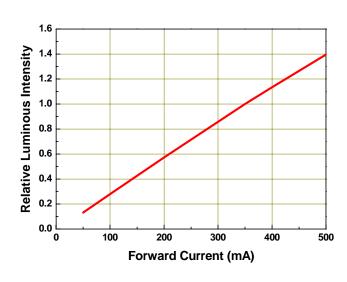
Relative Spectral Distribution,  $I_F$ =350mA,  $T_{Ambient}$ =25°C



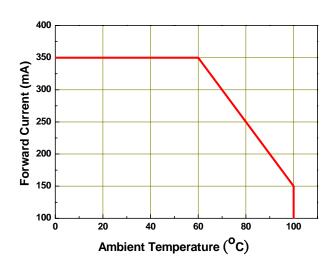
Forward Voltage vs Forward Current,  $T_{Ambient}$ =25°C



Relative Luminous Intensity vs Forward Current,  $T_{Ambient}$ =25°C



Forward Current Derating Curve, Derating based on T<sub>iMAX</sub>=125°C



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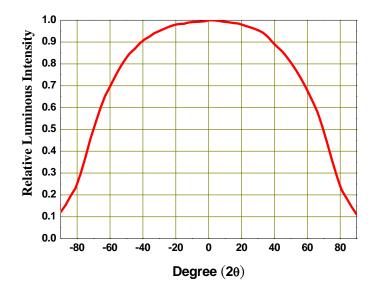
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## **Typical Representative Spatial Radiation Pattern**



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## EHP-AX08EL/SUR01A-P01

### Label explanation

**CPN: Customer's Production Number** 

P/N : Production Number QTY: Packing Quantity

**CAT: Ranks** 

**HUE: Dominant Wavelength** 

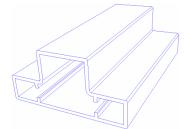
REF: Reference
LOT No: Lot Number

**MADE IN TAIWAN: Production Place** 

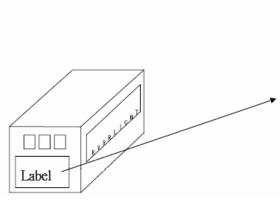


### **Tube Packing Specifications**

### 1. Tube



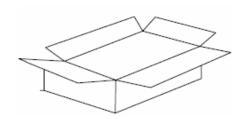
#### 3. Outside Carton



### Packing Quantity

- 1. 60 Pcs / Per Tube
- 2. 20 Tubes / Inner Carton
- 3. 12 Inner Cartons / Outside Carton

#### 2. Inner Carton





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## EHP-AX08EL/SUR01A-P01

**Reliability Test Items and Results** 

Stress Test	Stress Condition	Stress Duration		
Solderability	Tsol=230℃, 5sec	1 times		
Reflow	Tsol=260°ℂ, 10sec, 6min	3 times		
Thermal Shock	$H: +110^\circ\mathbb{C}$ 20min. ' $J$ 10sec. ' $L: -$ 40 $^\circ\mathbb{C}$ 20min.	500 Cycles		
Temperature Cycle	$egin{aligned} H &\colon + 100 ^\circ \!$	1000 Cycles		
High Temperature/Humidity Reverse Bias	Ta=85℃ , RH=85%	1000hours		
High Temperature/Humidity Operation	Ta=85℃ , RH=60%, IF=225mA	1000hours		
High Temperature Storage	Ta=110°C	1000hours		
Low Temperature Storage	Ta=-40°C	1000hours		
Intermittent operational Life	Ta=25℃, IF=1000mA 30mS on/ 2500mS off	1000hours		
High Temperature Operation Life #1	Ta=55°ℂ, IF=350mA	1000hours		
High Temperature Operation Life #2	Ta=85℃, IF=225mA	1000hours		
High Temperature Operation Life #3	Ta=100℃, IF=150mA	1000hours		
Low Temperature Operation Life	Ta=-40℃, IF=350mA	1000hours		
Power Temperature Cycle	$H: +85^\circ\mathbb{C}$ 15min. ' $\int$ 5min. ' $L: -40^\circ\mathbb{C}$ 15min. IF=225mA,2min on/off	1000cycles		
ESD Human Body Model	2000V, Interval:0.5sec	3 times		
ESD Machine Model	200V, Interval:0.5sec	3 times		

\*Im: BRIGHTNESS ATTENUATE DIFFERENCE(1000hrs) < 50%

\*VF: FORWARD VOLTAGE DIFFERENCE < 20%

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## EHP-AX08EL/SUR01A-P01

#### **Precautions For Use**

#### 1. Over-current-proof

Though EHP-A08 has conducted ESD protection mechanism, customer must not use the device in reverse and should apply resistors for extra protection. Otherwise slight voltage shift may cause enormous current change and burn out failure would happen.

### 2. Storage

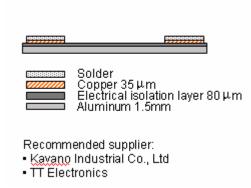
- i. Do not open moisture proof bag before the products are ready to use.
- ii. Before opening the package, the LEDs should be kept at 30℃ or less and 90%RH or less.
- iii. The LEDs should be used within a year.
- iv. After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.
- v. The LEDs should be used within 168 hours (7 days) after opening the package.
- vi. If the moisture absorbent material (silicone gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
- vii. Pre-curing treatment : 60±5°C for 24 hours.

#### 3. Thermal Management

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 For maintaining the high flux output and achieving reliability, EHP-A08 series LED package should be mounted on a metal core printed circuit board (MCPCB) with proper thermal connection to dissipate approximately 1W of thermal energy under 350mA operation.

### MCPCB structure



- ii. Special thermal designs are also recommended to take in outer heat sink design, such as FR4PCB on Aluminum with thermal vias or FPC on Aluminum with thermal conductive adhesive, etc.
- iii. Sufficient thermal management must be conducted, or the die junction temperature will be over the limit under large electronic driving and LED lifetime will decrease critically.

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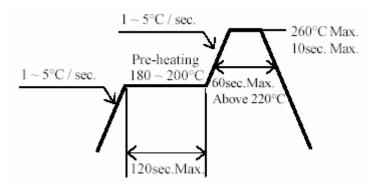
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### 4. Soldering Condition

Lead reflow soldering temperature profile İ.



- ii. Reflow soldering should not be done more than two times.
- iii. While soldering, do not put stress on the LEDs during heating.
- iv. After soldering, do not warp the circuit board

### 5. Soldering Iron

- For prototype builds or small series production runs it is possible to place and solder the LED by i. hand.
- ii. Dispensing thermal conductive glue or grease on the substrates and follow its curing spec. Press LED housing to closely connect LED and substrate.
- iii. It is recommended to hand solder the leads with a solder tip temperature of 280°C for less than 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal.
- Be careful because the damage of the product is often started at the time of the hand solder. iv.

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